DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention

METHOD FOR PRODUCING FLUORINE-CONTAINING (METH)ACRYLATE POLYMER AND POLYMER PRODUCED BY SUCH METHOD

ine specific	ation of which is attached hereto	unless the following is ch	ecked	
was filed was filed International	Sep. 29, 2006 d on as United States Appl d Application Number <u>PCT/JP20</u>	ication Number ar	4,977 id was filed on <u>March 25, 20</u> nded on(if applicable)	05 as PCT
I hereby star claim(s), as	te that I have reviewed and under amended by any amendment refe	stand the contents of the arred above.	above-identified specification	, including the
I acknowled Regulations	ge the duty to disclose information, § 1.56.	on which is material to pa	tentability as defined in Title	37, Code of Federal
I hereby clai for patent or inventor's co	im foreign priority benefits under inventor's certificate listed below ertificate having a filing date befo	Title 35, United States C v and have also identified tre that of the application	ode, § 119 (a) – (d) of any fo below any foreign application for which priority is claimed.	reign application(s) on for patent or
(List prior fore				Priority Claimed
applications. So	^{ec} 2004-101708	Japan		
note A)	(Number)	(Country)	31/03/2004 (Day/Month/Year Filed)	⊠ Yes □ No
	(Number)	(Country)	(Day/Month/Year Filed)	Yes No
	(Number)	(Country)	(Day/Month/Year Filed)	Yes No
·				☐ Yes ☐ No
(See note B)	(Number)	(Country)	(Day/Month/Year Filed)	
in the manner	n the benefit under Title 35, Unit subject matter of each of the clair provided by the first paragraph which is material to patentability a became available between the filipplication.	of Title 35, United State	S Code, § 112, I acknowledge	ted States application the the duty to disclose
List prior U.S.		Status	ıs	
Applications)	(Application Serial No.)	(Filing Date)	Patented Pending Abandoned	
	,	(
	(Application Serial No.)	(Filing Date)	☐ Patented ☐ Pending ☐ Abandoned	
	(Application Serial No.)	(Filing Date)	Patented Pending Abandoned	
	(Application Serial No.)	(Filing Date)	Patented Pendi	ng 🗌 Abandoned

I hereby appoint the following lorney(s) and/or agent(s) to prosecute this appear and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number: 38834

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP 1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

See note C)	Full name of sole or Inventor's signature	first inventor (given name, family name)	Etsuo HORII		
	Residence	Etsuo Horii	Date 10/11/2006		
	Post Office Address	Neyagawa-shi, Japan	Citizenship Japan		
	Tosi Office Address	3-6-302, Koori Nishino-cho, Neyagawa-shi, Osaka 572-0089 Japan			
	Full name of second	inventor (given name, family name)	Hirosuke KAWABATA		
	Inventor's signature	Minsule formapato	Date 10/11 (2006)		
	Residence	Akashi-shi, Japan	Citizenship Japan		
	Post Office Address	790-133, Nishiwaki, Okubo-cho, Akashi-shi, Hyogo 674-0054 Japan			
	Full name of third in	ventor (given name, family name)			
	Inventor's signature		Date (/2//3/2)		
	Residence	Suita-shi, Japan	Citizenship		
	Post Office Address		Japan		
		c/o Osaka University			
		1-1, Yamadaoka, Suita-shi, Osaka 565-	-0871 Japan		
	Full name of fourth in	iventor (given name, family name)	Akiya OGAWA		
	Inventor's signature	- Days Gran	Date ///02/2006		
	Residence	Sakai-shi, Japan	Citizenship Japan		
	Post Office Address	1-1, Gakuen-cho, Sakai-shi, Osaka 599-8531 Japan			
	Full name of fifth inve	entor (given name, family name)			
	Inventor's signature	Xiao liang Xu	Date Xiaoliang XU		
	Residence	Suita-shi, Japan	Citizenchin		
	Post Office Address	c/o Osaka University	Japan		
		1-1, Yamadaoka, Suita-shi, Osaka 565-0871 Japan			
		, series sing Osaika 303-	vo/1 Japan		
	Full name of sixth inventor (given name, family name) Inventor's signature Date				
	Residence		Citizenship		
	Post Office Address		- Citizenship		
	-				
	-				